

### Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

### General Features

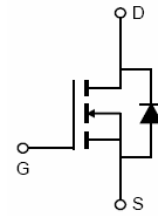
- $V_{DS} = 120V, I_D = 70A$   
 $R_{DS(ON)} = 8.5m\Omega$ , typical (TO-220) @  $V_{GS} = 10V$   
 $R_{DS(ON)} = 8.2m\Omega$ , typical (TO-263) @  $V_{GS} = 10V$
- Excellent gate charge x  $R_{DS(on)}$  product(FOM)
- Very low on-resistance  $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating



TO-263



TO-220C



Schematic Diagram

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST12N082-T3	VST12N082	TO-220C	-	-	-
VST12N082-TC	VST12N082	TO-263	-	-	-

### Absolute Maximum Ratings ( $T_C = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	120	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	70	A
Drain Current-Continuous( $T_C = 100^\circ C$ )	$I_D(100^\circ C)$	50	A
Pulsed Drain Current	$I_{DM}$	280	A
Maximum Power Dissipation	$P_D$	120	W
Derating factor		0.8	W/ $^\circ C$
Single pulse avalanche energy <sup>(Note 4)</sup>	$E_{AS}$	352	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 175	$^\circ C$

### Thermal Characteristic

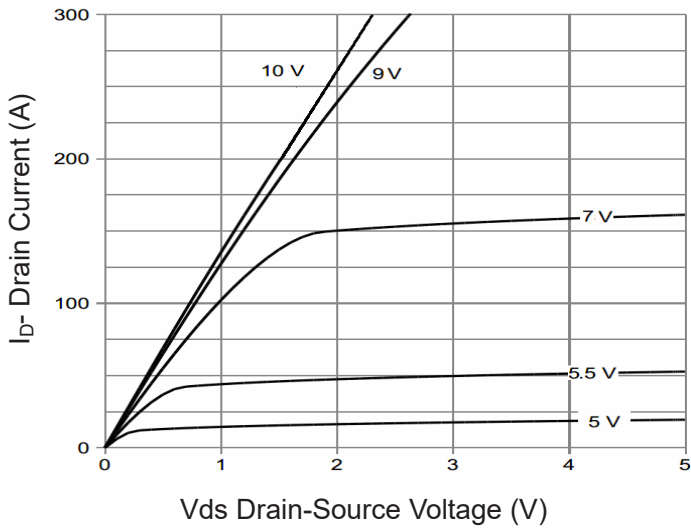
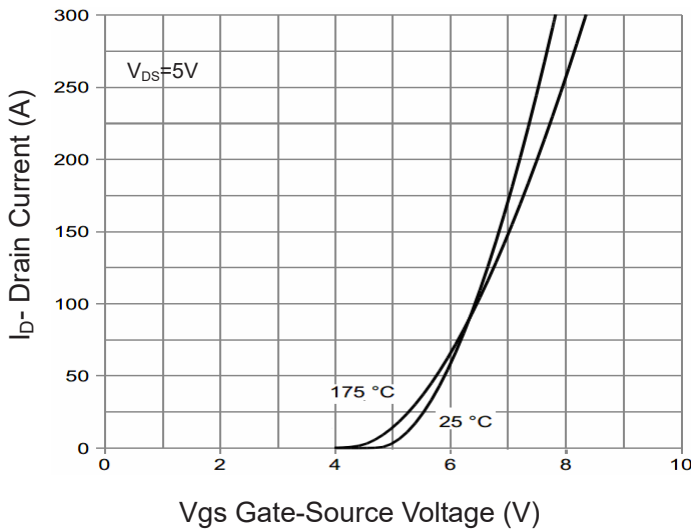
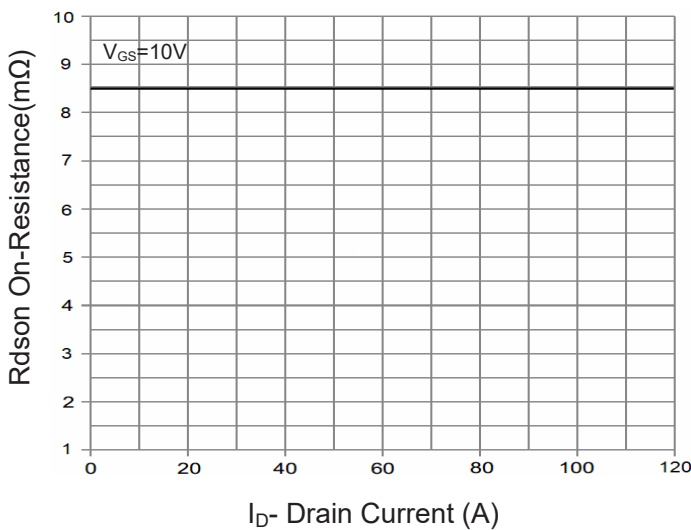
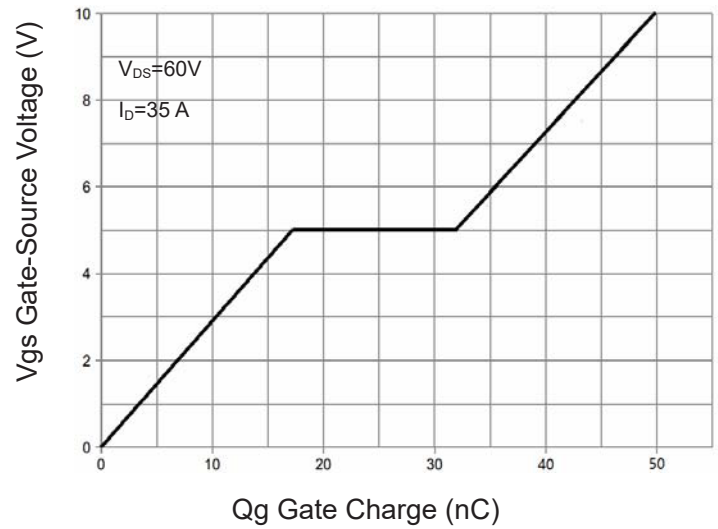
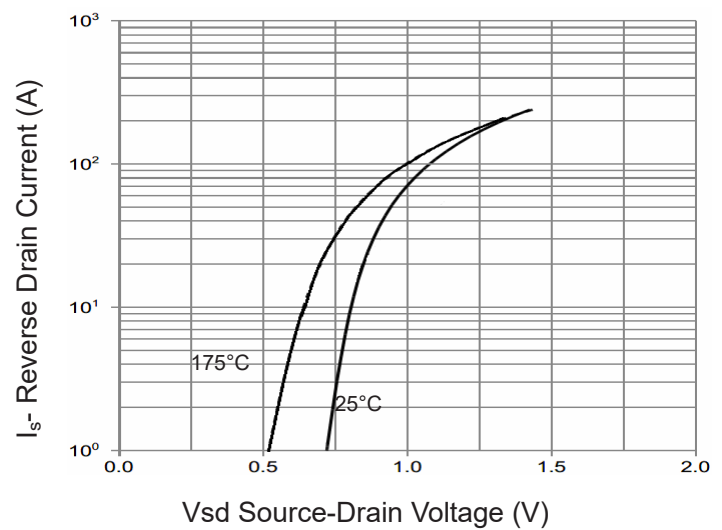
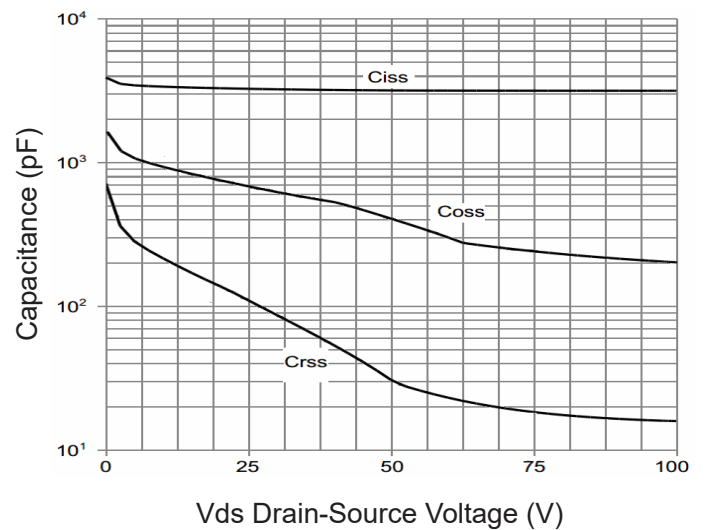
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.25	$^\circ C/W$
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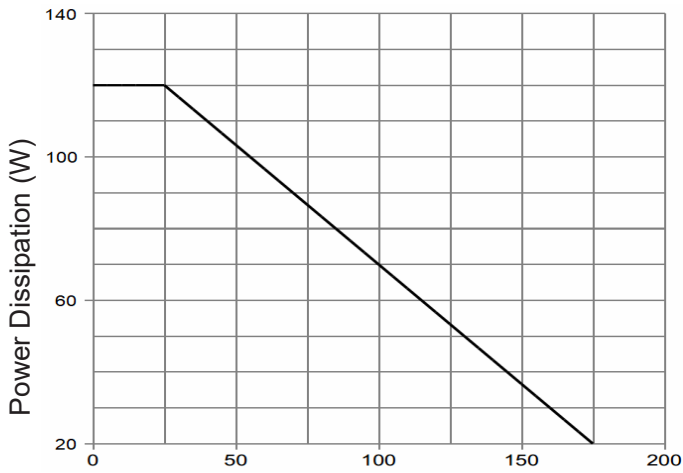
**Electrical Characteristics ( $T_C=25^{\circ}\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
<b>Off Characteristics</b>							
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	120		-	V	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=120V, V_{GS}=0V$	-	-	1	$\mu A$	
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA	
<b>On Characteristics</b> (Note 3)							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	3.0	4.0	V	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=35A$	TO-220	-	8.5	10.0	m $\Omega$
			TO-263		8.2	10.0	
Forward Transconductance	$g_{FS}$	$V_{DS}=5V, I_D=35A$		60	-	S	
<b>Dynamic Characteristics</b> (Note 3)							
Input Capacitance	$C_{iss}$	$V_{DS}=60V, V_{GS}=0V,$ $F=1.0MHz$	-	3050	-	pF	
Output Capacitance	$C_{oss}$		-	280	-	pF	
Reverse Transfer Capacitance	$C_{rss}$		-	22	-	pF	
<b>Switching Characteristics</b> (Note 3)							
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=60V, I_D=35A$ $V_{GS}=10V, R_G=1.6\Omega$	-	15	-	nS	
Turn-on Rise Time	$t_r$		-	10	-	nS	
Turn-Off Delay Time	$t_{d(off)}$		-	34	-	nS	
Turn-Off Fall Time	$t_f$		-	8	-	nS	
Total Gate Charge	$Q_g$	$V_{DS}=60V, I_D=35A,$ $V_{GS}=10V$	-	53	-	nC	
Gate-Source Charge	$Q_{gs}$		-	20	-	nC	
Gate-Drain Charge	$Q_{gd}$		-	12.5	-	nC	
<b>Drain-Source Diode Characteristics</b>							
Diode Forward Voltage (Note 2)	$V_{SD}$	$V_{GS}=0V, I_S=35A$	-	-	1.2	V	
Diode Forward Current	$I_S$		-	-	70	A	
Reverse Recovery Time	$t_{rr}$	$T_J = 25^{\circ}\text{C}, I_F = 35A$ $di/dt = 100A/\mu s$ (Note 3)	-	60	-	nS	
Reverse Recovery Charge	$Q_{rr}$		-	106	-	nC	

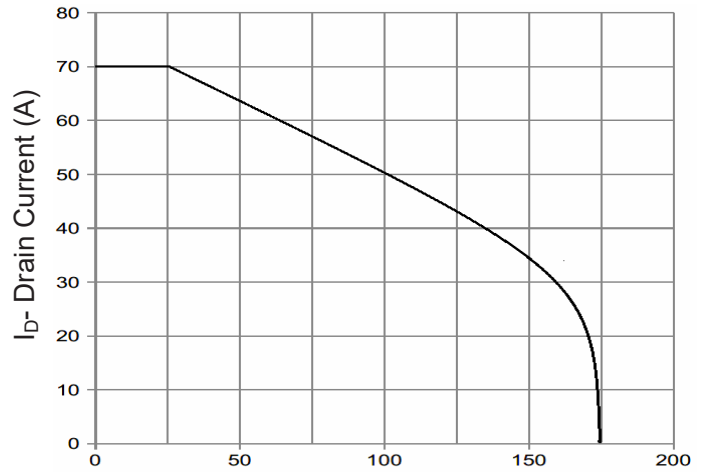
**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
3. Guaranteed by design, not subject to production
4. EAS condition :  $T_J=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, L=0.25mH, R_G=25\Omega$

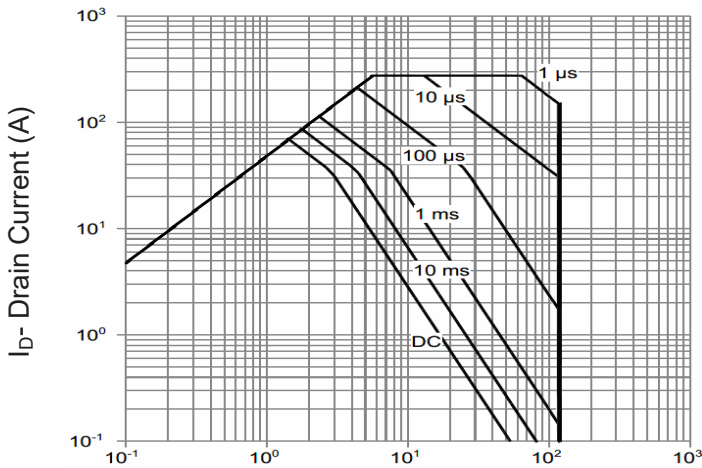
**Typical Electrical and Thermal Characteristics**

**Figure 1 Output Characteristics**

**Figure 2 Transfer Characteristics**

**Figure 3 Rdson- Drain Current**

**Figure 4 Gate Charge**

**Figure 5 Source- Drain Diode Forward**

**Figure 6 Capacitance vs Vds**



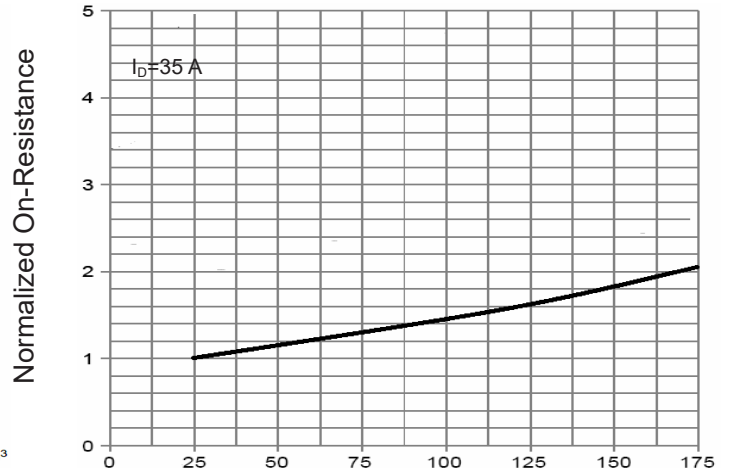
T<sub>J</sub>-Junction Temperature(°C)  
**Figure 7 Power De-rating**



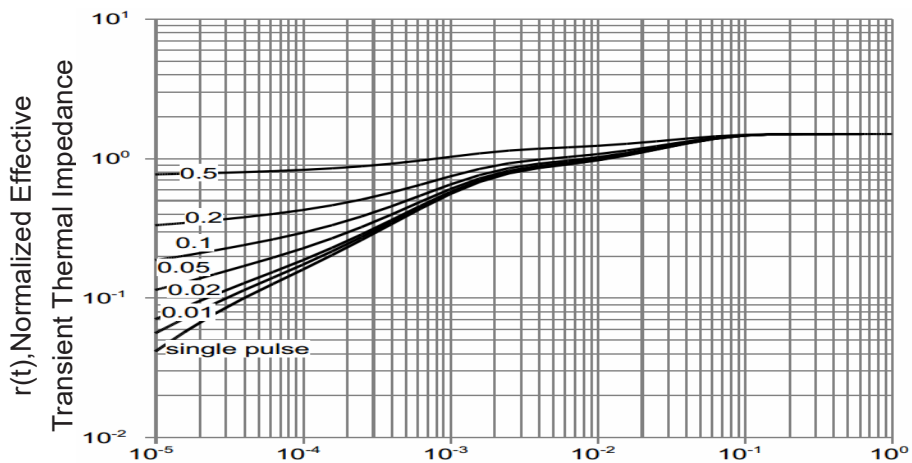
T<sub>J</sub>-Junction Temperature (°C)  
**Figure 9 Current De-rating**



V<sub>ds</sub> Drain-Source Voltage (V)  
**Figure 8 Safe Operation Area**



T<sub>J</sub>-Junction Temperature(°C)  
**Figure 10 Rdson-Junction Temperature**



Square Wave Pluse Duration(sec)  
**Figure 11 Normalized Maximum Transient Thermal Impedance**